

San Diego, CA, USA - July 2016

Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Credit
Abbott, Justin	Lumentum	Lumentum		1	1	1	3
Abramson, David	Texas Instruments Incorporated	Texas Instruments Incorporated	1	1	1	1	4
Abughazaleh, Shadi	Hubbell Incorporated	Hubbell Incorporated	1	1	1		3
Aekins, Rob	Legrand	Legrand		1	1		2
Ahmed, Mohammad	TE Connectivity	TE Connectivity	1	1	1		3
Anslow, Peter	Ciena Corporation	Ciena Corporation	1	1	1	1	4
Baden, Eric	Broadcom Corporation	Broadcom Corporation	1	1		1	3
Bains, Amrik	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Balasubramonian, Venugopal	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.		1	1		2
Baldwin, Thananya	Ixia	Ixia	1	1	1	1	4
Beaudoin, Denis	Texas Instruments Incorporated	Texas Instruments Incorporated	1	1	1	1	4
Beia, Christian	STMicroelectronics	STMicroelectronics		1	1	1	3
Belopolsky, Yakov	Self Employed	Bel Stewart Connector		1	1		2
Bhatt, Vipul	Inphi Corporation	Inphi Corporation	1	1	1		3
Bliss, William	Broadcom Corporation	Broadcom Corporation		1	1	1	3
Booth, Brad	Microsoft Corporation	Microsoft Corporation	1	1	1	1	4
Bouda, Martin	Fujitsu Laboratories of America, Inc.	Fujitsu Laboratories of America, Inc.	1	1	1	1	4
Brandt, David	Rockwell Automation	Rockwell Automation	1	1	1	1	4
Braun, Ralf-Peter	Deutsche Telekom AG	Deutsche Telekom AG	1	1	1	1	4
Brillhart, Theodore	Fluke Corporation	Fluke Corporation		1	1	1	3
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions	1	1	1	1	4
Brown, Alan M	CommScope	CommScope, Inc.	1	1	1	1	4
Brown, Matthew	Applied Micro (AMCC)	Applied Micro (AMCC)	1	1		1	3
Brownlee, Phillip	TDK Corporation	TDK Corporation	1	1	1	1	4
Bullock, Chris	Cisco Systems, Inc.	Cisco Systems, Inc.			1	1	2
Bustos Heredia, Jairo	Wurth Elektronik Group	Wurth Elektronik Group	1	1	1	1	4
Butter, Adrian	GLOBALFOUNDRIES	GLOBALFOUNDRIES	1	1	1	1	4
Caggioni, Francesco	AMCC	Applied Micro (AMCC)		1	1	1	3
Calbone, Anthony	Seagate Technology LLC	Seagate Technology LLC	1	1	1	1	4
Cantin, Pierre-Luc	Google	Google	1	1	1	1	4
Carlson, Steven	High-Speed Design Inc.	Robert Bosch GmbH	1	1	1	1	4
Carty, Clark	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4

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Chabot, Craig	University of New Hampshire InterOpera	University of New Hampshire InterOpera	1	1		1	3
Chadha, Mandeep	Microsemi Corporation	Microsemi Corporation	1	1	1	1	4
Chalupsky, David	Intel Corporation	Intel Corporation	1		1	1	3
Chang, Xin	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd		1	1	1	3
Chang, Yongmao	Inphi Corporation	Inphi Corporation	1		1	1	3
Chen, Chan	Applied Optoelectronics, Inc.	Applied Optoelectronics, Inc.		1	1		2
Cheng, Weiyang	Coriant	Coriant		1	1	1	3
Cheng, Wheling	Ericsson AB	Ericsson AB	1	1	1	1	4
Chini, Ahmad	Broadcom Corporation	Broadcom Corporation	1	1	1		3
Chung, Hwan Seok	Electronics and Telecommunications Res	Electronics and Telecommunications Res	1	1	1		3
Cole, Christopher R	Finisar Corporation	Finisar Corporation	1	1	1		3
Conroy, Keith	Acacia Communications	Acacia		1	1	1	3
Dai, Eugene	Cox Communications Inc.	Cox Communications Inc.		1	1	1	3
D'Ambrosia, John	Futurewei Technologies	Futurewei (Subsidiary of Huawei)	1	1	1	1	4
Darshan, Yair	Microsemi Corporation	Microsemi Corporation		1		1	2
Dawson, Fred	Chemours Canada Company	Chemours Canada Company	1	1		1	3
Diab, Wael	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Dillard, John	Microsemi Corporation	Microsemi Corporation	1	1	1	1	4
Dillow, Daniel	FCI Electronics	FCI USA Inc.	1	1	1		3
Diminico, Christopher	M C Communications, LLC	Panduit Corp.		1	1	1	3
Dinh, Thuyen	Pulse Electronics	Pulse Electronics	1		1	1	3
Donahue, Curtis	University of New Hampshire InterOpera	UNH-IOL	1	1	1	1	4
Dove, Daniel	Dove Networking Solutions	DNS - 802.3 / Linear Technology - P802.3	1	1	1		3
Dudek, Michael	QLogic Corporation	QLogic Corporation	1	1	1	1	4
Dupuis, Marc	Web Industries	Web Industries	1	1	1		3
Dwelle, David	Linear Technology	Linear Technology	1	1			2
Effenberger, Frank	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Estes, David	Spirent Communications	Spirent Communications	1	1	1	1	4
Ewen, John	GLOBALFOUNDIRES	GLOBALFOUNDIRES	1	1	1	1	4
farjad, ramin	Aquantia	Aquantia	1	1	1		3
Feldman, Shahar	Microsemi Corporation	Microsemi Corporation		1	1	1	3
Feyh, German	Broadcom Corporation	Broadcom Corporation		1	1		2

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Fife, James	eTopus Technology, Inc.	eTopus Technology, Inc.		1	1	1	3
Filip, Jan	Maxim Integrated Products	Maxim Integrated Products		1			1
Flatman, Alan	LAN Technologies Corporation, Inc.	LAN Technologies Corporation, Inc.	1	1	1		3
Foltz, Mark	ABB, Inc.	ABB, Inc.	1			1	2
Fritsche, Matthias	HARTING Technologie Gruppe	HARTING Electronics GmbH	1	1	1	1	4
Frosch, Richard	Phihong USA Inc,	Phihong USA Inc,		1	1	1	3
Funada, Tomoyuki	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD	1	1	1		3
Gardner, Andrew	Linear Technology	Linear Technology	1	1	1	1	4
Gauthier, Claude	OmniPhy	OmniPhy	1	1		1	3
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC, Huawei LTD	1	1	1	1	4
Goergen, Joel	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Gong, Zhigang	O-Net Communications Ltd.	O-Net Communications Ltd.	1	1	1	1	4
Gorshe, Steven Scott	PMC-Sierra, Inc.	PMC-Sierra, Inc.	1	1	1	1	4
Grow, Robert	RMG Consulting	RMG Consulting, KDPOF	1	1	1	1	4
GUO, YONG	ZTE Corporation	ZTE Corporation		1	1	1	3
Gupta, Atul		macom				1	1
Gustlin, Mark	Xilinx	Xilinx	1	1	1	1	4
Haasz, Jodi	IEEE - Institute of Electrical and Electroni	IEEE Standards Association (IEEE-SA)			1		1
Hajduczenia, Marek	Charter Communications	Charter Communications	1	1	1	1	4
Hamidy, Farid	Pulse Electronics	Pulse Electronics		1			1
Harstead, Ed	ALCATEL-LUCENT	ALCATEL-LUCENT		1	1		2
Hashimoto, Tomohiro	socionext	socionext		1	1	1	3
Hayashi, Takehiro	HAT Lab., Inc.	HAT Lab., Inc.	1	1	1	1	4
He, Wilson	Accelink Technologies Co. Ltd	Accelink Technologies Co. Ltd	1		1	1	3
Healey, Adam	Broadcom Ltd.	Broadcom Ltd.	1	1	1	1	4
Hegde, Rajmohan	Broadcom Corporation	Broadcom Corporation	1	1	1	1	4
Hess, David	CORD DATA	CORD DATA	1	1	1	1	4
Hidaka, Yasuo	Fujitsu Laboratories of America, Inc.	Fujitsu Laboratories of America, Inc.	1	1	1	1	4
Hitz, Tim	NetScout Systems, Inc.	NetScout Systems, Inc.		1			1
Hoglund, David	Johnson Controls Inc	Johnson Controls Inc	1	1	1	1	4
Horner, Rita	Synopsys, Inc.	Synopsys, Inc.	1	1	1		3
Hormmeyer, Bernd	Phoenix Contact	Phoenix Contact	1	1	1	1	4

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Huang, Jing	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1			1	2
HYAKUTAKE, YASUHIRO	Adamant Co., Ltd.	Adamant Co., Ltd.	1	1	1	1	4
Ingham, Jonathan	Foxconn Interconnect Technology	Foxconn Interconnect Technology		1	1		2
ISHIBE, KAZUHIKO	Anritsu Company	Anritsu Company	1	1	1	1	4
Isono, Hideki	FUJITSU	Fujitsu Optical Components Limited	1	1	1	1	4
Issenhuth, Tom	Microsoft Corporation	Microsoft Corporation	1	1	1	1	4
Jackson, Kenneth	Sumitomo Electric Device Innovations, U	Sumitomo Electric Industries, LTD	1	1	1	1	4
Jethanandani, Mahesh	Cisco Systems, Inc.	Cisco Systems, Inc.	1		1	1	3
Jimenez, Andrew	Anixter Inc.	Anixter Inc.		1	1	1	3
Johnson, John	Broadcom Limited	Broadcom Limited	1	1	1	1	4
Jones, Chad	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Jones, Peter	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Kagami, Manabu	Toyota Central R&D Labs	Toyota Central R&D Labs	1	1	1	1	4
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
KAWAHARA, KEISUKE	FURUKAWA ELECTRIC	FURUKAWA ELECTRIC	1	1	1	1	4
Kawatsu, Yasuaki	Hitachi Metals, Ltd.	Hitachi Metals, Ltd.	1	1	1	1	4
Khan, Ali	Corigine, Inc.	Corigine, Inc.	1				1
Kim, Yongbum	Broadcom Corporation	Broadcom Corporation	1	1	1	1	4
Kipp, Scott	Brocade Communications Systems, Inc.	Brocade Communications Systems, Inc.	1	1	1		3
Klempa, Michael	University of New Hampshire InterOpera	University of New Hampshire InterOpera	1	1	1	1	4
Knittle, Curtis	Cable Television Laboratories Inc. (Cable	Cable Television Laboratories Inc. (Cable	1	1	1		3
Kobayashi, Shigeru	Tyco Electronics Japan	TE Connectivity		1	1	1	3
Koehler, Daniel	MorethanIP	MorethanIP	1	1	1	1	4
Kolesar, Paul	CommScope, Inc.	CommScope, Inc.	1	1	1	1	4
Kramer, Glen	Broadcom Corporation	Broadcom Corporation	1	1	1	1	4
Krishnasamy, Kumaran	Broadcom Corporation	Broadcom Corporation	1	1			2
Lackner, Hans	QoSCom GmbH	QoSCom - Quality in Communications - G		1	1	1	3
Lapak, Jeffrey	University of New Hampshire InterOpera	University of New Hampshire InterOpera	1	1	1	1	4
Laubach, Mark	Broadcom Limited	Broadcom Corporation	1	1	1	1	4
Law, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1	4
Lee, Han Hyub	ETRI	ETRI	1	1	1		3
Leizerovich, Hanan	Multiphy	Multiphy	1	1	1	1	4

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Lewis, David	Lumentum Inc.	Lumentum Inc.	1	1	1	1	4
Lewis, Jon	Dell	Dell	1	1	1	1	4
Li, Mike-Peng	Intel Corporation	Intel Corporation	1	1	1	1	4
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Lin, Juitse	MediaTek Inc.	global unichip	1	1	1		3
liu, dekun		Huawei Technologies Co. Ltd	1	1	1	1	4
Liu, Hai-Feng	Intel	Intel Corporation	1	1	1	1	4
Liu, Jackie	Cisco Systems, Inc.	Cisco Systems, Inc.		1	1	1	3
Liu, Karen	Kaia Corp	Kaia Corporation		1			1
Liu, Qian	Research Institute of Telecommunication	Research Institute of Telecommunication	1				1
Lo, William	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.		1	1		2
Lokhandwala, Moiz	Charter Communications	Charter Communications	1	1	1	1	4
Lukacs, Miklos	Silicon Laboratories	Silicon Laboratories	1	1	1	1	4
Lusted, Kent	Intel Corporation	Intel Corporation	1	1	1	1	4
Maguire, Valerie	The Siemon Company	The Siemon Company	1	1	1	1	4
Maki, Jeffery	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1	4
Malicoat, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1	4
Marris, Arthur	Cadence Design Systems, Inc.	Cadence Design Systems, Inc.	1	1	1	1	4
MASUDA, TAKEO	OITDA	OITDA		1	1	1	3
Matheus, Kirsten	BMW Group	BMW Group	1	1		1	3
Matsuda, Naoki	National Institute of Advanced Industrial Science and Technology	National Institute of Advanced Industrial Science and Technology	1	1	1	1	4
McCarthy, Mick	Analog Devices Inc.	Analog Devices Inc.	1	1	1	1	4
McClellan, Brett	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1		3
Mccurdy, Alan	OFS-Fitel, LLC	OFS-Fitel, LLC		1	1	1	3
Mcdermott, Thomas	FUJITSU	FUJITSU	1	1	1	1	4
McDonough, John	NEC Corporation	NEC America		1	1	1	3
McMillan, Larry	Western Digital Corporation	Western Digital Corporation		1	1	1	3
McSorley, Gregory	Amphenol Corporation	Amphenol Corporation	1	1	1	1	4
Mei, Richard	CommScope, Inc.	CommScope, Inc.	1	1	1	1	4
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.	1	1	1	1	4
Migueluez, Phil	Comcast	Comcast		1	1		2
Moffitt, Bryan	CommScope	CommScope, Inc.	1	1	1	1	4

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Mooney, Paul	Spirent Communications	Spirent Communications	1	1	1	1	4
Moritake, Toshiyuki	Japan Aviation Electronics Ind., LTD. (JAE)	Japan Aviation Electronics Ind., LTD. (JAE)	1	1	1		3
Muir, Ron	JAE	Japan Aviation Electronics Ind., LTD. (JAE)	1	1	1		3
Murray, Dale	LightCounting LLC	LightCounting LLC	1	1	1		3
Muyshondt, Henry	Microchip Technology, Inc.	Microchip Technology, Inc.	1	1	1		3
Nakamoto, Edward	Spirent Communications	Spirent Communications	1	1	1	1	4
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Noll, Kevin	Time Warner Cable Inc.	Time Warner Cable Inc.	1	1	1	1	4
Nordin, Ronald	Panduit Corp.	Panduit Corp.	1	1	1		3
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Ofelt, David	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1		3
Palkert, Thomas	EIC	Luxtera-Molex-MoSys	1	1		1	3
Pandey, Sujan	NXP Semiconductors	NXP Semiconductors	1	1	1	1	4
Panguluri, Sesha	Broadcom Corporation	Broadcom Corporation	1	1	1		3
Pardo, Carlos	Knowledge Development for POF SL	KDPOF			1	1	2
Parsons, Earl	CommScope, Inc.	CommScope, Inc.	1	1	1		3
Parthasarathy, Vasu	Broadcom Corporation	Broadcom Corporation			1		1
Patra, Lenin	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1		3
Paul, Michael	Linear Technology	Linear Technology		1	1		2
Pepper, Gerald	Ixia	Ixia	1	1	1	1	4
Perez De Aranda Alonso, Ruben	Knowledge Development for POF SL	KDPOF			1	1	2
Peters, Michael	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD	1	1	1	1	4
Peterson, Harry	Yanntek Inc	Yanntek Inc; Quantum Leap		1	1	1	3
Pham, Phong	US Conec, Ltd.	US Conec, Ltd.	1	1	1	1	4
Pimpinella, Rick	Panduit Corp.	Panduit Corp.		1	1		2
Powell, William	ALCATEL-LUCENT	Nokia	1	1	1		3
Rabinovich, Rick	Ixia	Ixia	1	1	1	1	4
Rahn, Jeffrey	Infinera Corporation	Infinera Corporation	1	1	1	1	4
RAN, ADEE	Intel Corporation	Intel Corporation	1	1	1	1	4
Remain, Duane	Futurewei Technologies	Huawei Technologies Co. Ltd	1	1	1		3
Renteria, Victor	Bel Fuse	Bel Fuse		1			1
Ressler, Michael	Hitachi, Ltd.	Hitachi Cable America Inc.	1	1	1		3

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Sakai, Toshiaki	socionext	socionext	1	1	1	1	4
Salinger, Jorge	Comcast	Comcast	1	1	1		3
Sambasivan, Sam	AT&T	AT&T	1	1	1	1	4
Sayre, Edward	Teraspeed Consulting, a division of Samt	Teraspeed, a division of Samtec	1	1	1	1	4
Sedarat, Hossein	Aquantia	Aquantia	1	1	1	1	4
SERIZAWA, NAOSHI	Yazaki Corporation	Yazaki Corporation		1	1	1	3
Shariff, Masood	CommScope, Inc.	CommScope, Inc.	1	1	1	1	4
Shigematsu, Masayuki	Innovation Core SEI	Innovation Core SEI		1	1	1	3
shirani, ramin	Aquantia	Aquantia	1	1	1	1	4
Shrikhande, Kapil	Innovium Inc.	Innovium		1	1	1	3
Slavick, Jeff	Broadcom Limited	Broadcom Limited	1	1	1	1	4
Smith, Daniel	Seagate Technology LLC	Seagate Technology LLC	1	1	1	1	4
Sommers, Scott	Molex Incorporated	Molex Incorporated	1	1	1	1	4
Sone, Yoshiaki	NTT	Nippon Telegraph and Telephone Corpor		1	1	1	3
Sparrowhawk, Bryan	Leviton Manufacturing Co.	Leviton Manufacturing Co.	1	1	1	1	4
Srivastava, Atul	NEL-America	NTT Electronics	1	1	1	1	4
Stassar, Peter	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Stencel, Leonard	Bourns, Inc.	Bourns, Inc.	1	1	1	1	4
Stewart, Heath	Linear Technology	Linear Technology	1	1	1		3
Stone, Robert	Broadcom Corporation	Broadcom Corporation	1	1	1	1	4
Stover, David	Linear Technology	Linear Technology	1	1	1		3
Sun, Junqing	Credo Semiconductor	Credo Semiconductor	1	1	1	1	4
Suzuki, Ken-Ichi	Nippon Telegraph and Telephone Corpo	NTT	1	1	1	1	4
Svendsen, Justin	Hitachi, Ltd.	CIT	1	1	1		3
Swanson, Steven	Corning Incorporated	Corning Incorporated	1	1	1	1	4
Szczepanek, Andre	Inphi Corporation	Inphi Corporation	1	1	1	1	4
Szeto, William	xtera	xtera	1	1	1	1	4
Tailor, Bharat	Semtech Canada Corporation	Semtech Canada Corporation	1	1	1	1	4
Tajima, Takayuki	Yazaki Corporation	Yazaki Corporation		1	1	1	3
TAKAHARA, TOMOO	Fujitsu Optical Components Limited	FUJITSU LABORATORIES LIMITED	1	1	1	1	4
Takahashi, Satoshi	Self Employed	Self Employed	1	1	1	1	4
Tamura, Kohichi	Oclaro Japan Inc.	Oclaro Japan Inc.	1	1	1	1	4

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TANAKA, Naruto	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD			1		1
TAZEBAY, MEHMET	Broadcom Corporation	Broadcom Corporation	1			1	2
Tellas, Ronald	Belden	Belden		1		1	2
Thompson, Geoffrey	GraCaSI S.A.	INDEPENDENT	1	1		1	3
Toyserkani, Pirooz	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Tracy, Nathan	TE Connectivity	TE Connectivity	1	1	1	1	4
Traverso, Matthew	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1		3
Tretter, Albert	Siemens AG	Siemens AG	1	1	1	1	4
Trowbridge, Stephen	Nokia	Nokia	1	1	1	1	4
Tsukamoto, Yoshihiro	Mitsubishi Rayon Co. Ltd.	Mitsubishi Rayon Co. Ltd.		1	1	1	3
Tucker, Ryan	Charter Communications	Charter Communications		1	1		2
Ulrichs, Ed	Source Photonics	Source Photonics	1	1	1	1	4
Umnov, Alexander	Corning Incorporated	FUJITSU	1	1	1		3
Vaden, Sterling	Vaden Enterprises	Vaden Enterprises		1	1	1	3
Valle, Stefano	STMicroelectronics	STMicroelectronics	1	1	1		3
Vanderlaan, Paul	Berk-Tek LLC	Berk-Tek LLC	1	1	1	1	4
VITTAL, BALASUBRAMANIAN	Dell	Dell	1	1	1	1	4
Walker, Dylan	Cisco Systems, Inc.	Cisco Systems, Inc.		1	1	1	3
Wang, Robert	Intel Corporation	Intel Corporation	1	1	1		3
Wang, Tongtong	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Wang, Xiaofeng	Qualcomm Incorporated	Qualcomm Incorporated	1	1		1	3
Wang, Xinyuan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1		1	3
Welch, Brian	Luxtera	Luxtera		1	1	1	3
Wen, Yangyang	Maxim Integrated Products	Maxim Integrated Products			1	1	2
Wendt, Matthias	Philips Lighting	Philips Lighting	1	1	1	1	4
Wertheim, Oded	Mellanox Technologies	Mellanox Technologies	1	1	1	1	4
white, martin	Cavium	Cavium	1	1	1		3
Wienckowski, Natalie	General Motors Company	General Motors Company	1	1		1	3
Winkel, Ludwig	Siemens AG	Siemens AG	1	1	1	1	4
Xu, Dayin	Rockwell Automation	Rockwell Automation	1	1	1	1	4
Xu, Yu	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Yasueda, Jim	Teledyne Lecroy	Teledyne Lecroy		1	1		2

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Yseboodt, Lennart	Philips Electronics	Philips Electronics	1	1	1	1	4
YUKI, HAYATO	AutoNetworks Technologies Ltd.	AutoNetworks Technologies Ltd.	1	1	1	1	4
Zhao, Wenyu	Research Institute of Telecommunication	China Academy of Telecommunication R	1	1	1		3
Zheng, Jie	Foxconn Electronics Inc.	Foxconn Electronics Inc.		1	1		2
Zhong, Qiwen	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd		1	1	1	3
Zhuang, Yan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1		3
Zimmerman, George	CME Consulting	Aquantia, CommScope, Inc., Linear Techn	1	1	1		3
Zinner, Helge	Continental Automotive Systems AG	Continental Automotive Systems AG	1	1		1	3
Zou, Gaoling	Maxim Integrated Products	Maxim Integrated Products		1	1	1	3